

PTC thermistors for overcurrent protection

SMDs, EIA sizes 0603 and 1210, 24 V, 42 V, 63 V and 230 V

Series/Type: B59606, B59607, B59707, B59807, B59907, B5962* Date: February 2012

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<u>SMD</u>

Applications

- Overcurrent protection
- Short circuit protection

Features

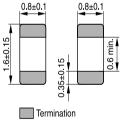
- Qualification based on AEC-Q200 rev. D for type A907
- Thermistor chip with lead-free tinned terminations
- Small size
- Short response times
- Suitable for reflow soldering only
- Suitable for automatic placement
- UL approval for selcted types (case size 1210)
- RoHS-compatible

Delivery mode

Blister tape (case size 1210) or cardboard tape (case size 0603), 180-mm reel with 8-mm tape, taping to IEC 60286-3

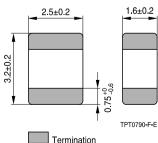
Dimensional drawings in mm

EIA case size 0603

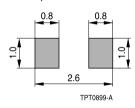


TPT0698-5-E

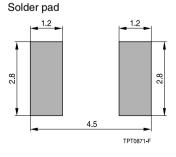
EIA case size 1210



Recommended maximum dimensions (mm)



Solder pad



Please read *Cautions and warnings* and *Important notes* at the end of this document.



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General technical data

Switching cycles		Ν	100	
Tolerance of R _R	(except A907)	ΔR_{R}	±25	%
Tolerance of R _B	(for A907)	ΔR_{R}	±35	%
Operating temperature range	(V = 0)	T _{op}	-40/+125	°C
Operating temperature range	$(V = V_{max}, except A907)$	T _{op}	-20/+85	°C
Operating temperature range	$(V = V_{max}, \text{ for A907})$	T _{op}	-40/+85	°C

Electrical specifications and ordering codes

Approvals

1.1.								
Туре	I _R ¹⁾	I _S ¹⁾	I _{Smax}	R _R	R _{min}	EIA	Approvals	Ordering code
			$(V = V_{max})$			case		
	mA	mA	А	Ω	Ω	size	71	
$V_{max} = 30 \text{ V DC or V AC}, V_{R} = 24 \text{ V DC or V AC}$								
A606	90	180	0.5	27	17	1210	Х	B59606A0110A062
A607	70	130	0.4	55	30	1210	х	B59607A0120A062
$V_{max} = 60 \text{ V DC or V AC}, V_{R} = 42 \text{ V DC or V AC}$								
A622	20	40	0.22	220	150	0603	-	B59622A0090A062
$V_{max} = 80 \text{ V DC or V AC}, V_{R} = 63 \text{ V DC or V AC}$								
A623	13	25	0.15	470	300	0603	_	B59623A0090A062
A707	50	90	0.3	125	75	1210	х	B59707A0120A062
$V_{max} = 265 \text{ V DC or V AC}, V_{R} = 230 \text{ V DC or V AC}$								
A807	15	40	0.2	400	200	1210	Х	B59807A0090A062
$V_{max} = 400 \text{ V DC or V AC}, V_{R} = 230 \text{ V DC or V AC}$								
A907	12	22	0.15	1500	640	1210	Х	B59907A0120A062

1) Measured on component soldered to standardized PCB



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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I _{Smax} ; V _{max}	< 25%
cycling		Number of cycles: 100	
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op,max} (V _{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 V), T_2 = T_{op,max} (0 V)$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency range: 10 - 55 - 10 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: 3×2 h	
		Test according to IEC 60068-2-6, test Fc	
Shock	IEC 60738-1	Pulse shape: half-sine	< 5%
		Acceleration: 390 m/s ²	
		Pulse duration: 6 ms; 6 x 4000 pulses	
		Test according to IEC 60068-2-27, test Ea	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}(0 V)$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 V)$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	
Bending test	IEC 60738-1	Components reflow-soldered to test board	< 10%
		Maximum bending: 2 mm	
		Test according to IEC 60068-2-21, test Ue	
Adhesive strength on		Shearing of the component soldered on	No visible
PCB		PCB by a force of 5 N normal to	damage
		components longitudinal axis	



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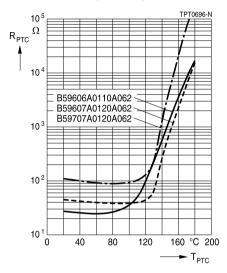
<u>SMD</u>

Characteristics (typical) for A606, A607 and A707

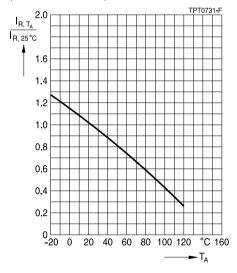
PTC resistance R_{PTC} versus

PTC temperature T_{PTC}

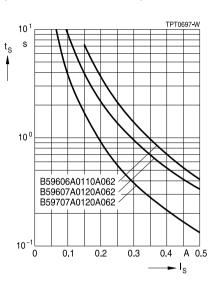
(measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)



Switching time t_s versus switching current I_s (measured at 25 °C in still air)



Please read *Cautions and warnings* and *Important notes* at the end of this document.



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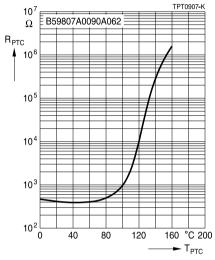
SMD

Characteristics (typical) for A807

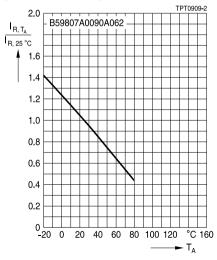
PTC resistance R_{PTC} versus

PTC temperature T_{PTC}

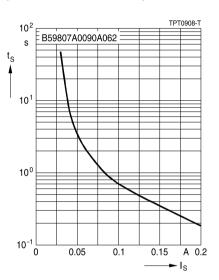
(measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)



Switching time t_s versus switching current I_s (measured at 25 °C in still air)





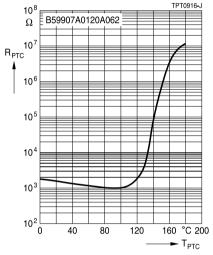
SMDs, EIA sizes 0603 and 1210, 24 V, 42 V, 63 V and 230 V

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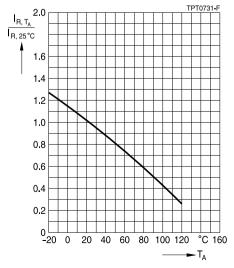
Characteristics (typical) for A907

PTC resistance R_{PTC} versus

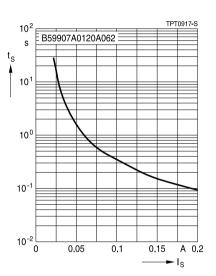
PTC temperature T_{PTC} (measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)



Switching time t_s versus switching current I_s (measured at 25 °C in still air)



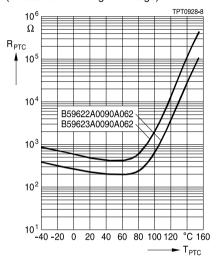


SMDs, EIA sizes 0603 and 1210, 24 V, 42 V, 63 V and 230 V

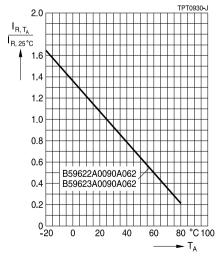
SMD

Characteristics (typical) for A622 and A623

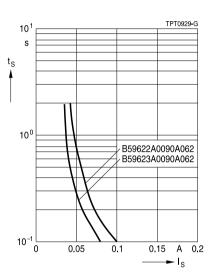
PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)



Switching time t_s versus switching current I_s (measured at 25 °C in still air)





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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).



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Symbols and terms

А	Area
С	Capacitance
C _{th}	Heat capacity
f	Frequency
I	Current
l _{max}	Maximum current
I _R	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
l _r	Residual currrent
I _{r,oil}	Residual currrent in oil (for level sensors)
$I_{r,air}$	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
ls	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
Ν	Number (integer)
N _c	Operating cycles at V_{max} , charging of capacitor
N _f	Switching cycles at V_{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P _{el}	Electrical power
P_{diss}	Dissipation power
R _G	Generator internal resistance
R _{min}	Minimum resistance
R _R	Rated resistance
ΔR_R	Tolerance of R _R
R _P	Parallel resistance
R _{PTC}	PTC resistance
R _{ref}	Reference resistance
Rs	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅
Т	Temperature
t	Time
T _A	Ambient temperature
t _a	Thermal threshold time



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T _c	Ferroelectric Curie temperature
	Settling time (for level sensors)
t _E T _R	Rated temperature
	•
T _{sense} T	Sensing temperature
T _{op} T	Operating temperature
T _{PTC}	PTC temperature
t _R T	Response time
T _{ref}	Reference temperature
T _{Rmin}	Temperature at minimum resistance
t _s -	Switching time
T _{surf}	Surface temperature
UCT	Upper category temperature
V or V _{el}	Voltage (with subscript only for distinction from volume)
V _{c(max)}	Maximum DC charge voltage of the surge generator
$V_{F,max}$	Maximum voltage applied at fault conditions in protection mode
V _{RMS}	Root-mean-square value of voltage
V_{BD}	Breakdown voltage
V _{ins}	Insulation test voltage
$V_{link,max}$	Maximum link voltage
V _{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V _{meas}	Measuring voltage
$V_{\text{meas,max}}$	Maximum measuring voltage
V _R	Rated voltage
V _{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
$ au_{th}$	Thermal cooling time constant
λ	Failure rate
е	Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.

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- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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